

APBL3025SURKZGKC

3.0 x 2.5 mm Surface Mount LED Lamp



DESCRIPTIONS

- The Hyper Red source color devices are made with AlGaInP on GaAs substrate Light Emitting Diode
- The Green source color devices are made with InGaN on Sapphire Light Emitting Diode
- · Electrostatic discharge and power surge could damage the LEDs
- . It is recommended to use a wrist band or anti-electrostatic glove when handling the LEDs
- · All devices, equipments and machineries must be electrically grounded

FEATURES

- 3.0 mm x 2.5 mm SMD LED, 1.4 mm thickness
- Low power consumption
- Wide viewing angle
- · Ideal for backlight and indicator
- · Inner lens type
- Package: 2000 pcs / reel
- Moisture sensitivity level: 3
- · Halogen-free
- · RoHS compliant

APPLICATIONS

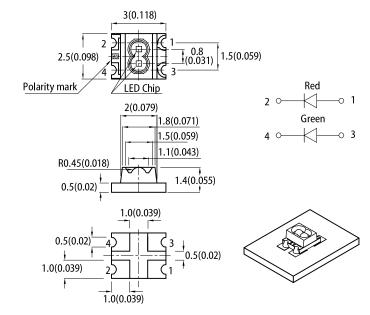
- Backlight
- · Status indicator
- Home and smart appliances
- · Wearable and portable devices
- · Healthcare applications

ATTENTION

Observe precautions for handling electrostatic discharge sensitive devices

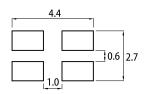


PACKAGE DIMENSIONS



RECOMMENDED SOLDERING PATTERN

(units: mm; tolerance: \pm 0.1)



- 17. All dimensions are in millimeters (inches).
 2. Tolerance is ±0.2(0.008") unless otherwise noted.
 3. The specifications, characteristics and technical data described in the datasheet are subject to change without prior notice.
- The device has a single mounting surface. The device must be mounted according to the specifications.

SELECTION GUIDE

Part Number	Emitting Color (Material)	Lens Type	Iv (mcd) @ 20mA [2]		Viewing Angle [1]	
			Min.	Тур.	2θ1/2	
APBL3025SURKZGKC		- Water Clear	500	1000		
	■ Hyper Red (AlGaInP)		*120	*300	50°	
	■ Green (InGaN)		700	1800		
			*700	*1800		

1. 81/2 is the angle from optical centerline where the luminous intensity is 1/2 of the optical peak value.
2. Luminous intensity / luminous flux: +/-15%.

**Luminous intensity / luminous flux: -/-15%.

Luminous intensity value is traceable to CIE127-2007 standards.



ELECTRICAL / OPTICAL CHARACTERISTICS at T_A=25°C

Parameter	Symbol	Emitting Color	Value		Unit
			Тур.	Max.	
Wavelength at Peak Emission I _F = 20mA	λ_{peak}	Hyper Red Green	645 515	-	nm
Dominant Wavelength I _F = 20mA	λ _{dom} ^[1]	Hyper Red Green	630 525	-	nm
Spectral Bandwidth at 50% Φ REL MAX I _F = 20mA	Δλ	Hyper Red Green	28 35	-	nm
Capacitance	С	Hyper Red Green	35 45	-	pF
Forward Voltage I _F = 20mA	V _F ^[2]	Hyper Red Green	1.95 3.3	2.5 4.1	V
Reverse Current (V _R = 5V)	I _R	Hyper Red Green	-	10 50	μА

Notes:

Nuces.

1. The dominant wavelength (\(\lambda\)) above is the setup value of the sorting machine. (Tolerance \(\lambda\) : \(\pm 1.1 \) the dominant wavelength (\(\lambda\)) above is the setup value of the sorting machine. (Tolerance \(\lambda\) : \(\pm 1.1 \) the value is traceable to CIE127-2007 standards.

3. Wavelength value is traceable to CIE127-2007 standards.

4. Excess driving current and / or operating temperature higher than recommended conditions may result in severe light degradation or premature failure.

ABSOLUTE MAXIMUM RATINGS at T_A =25°C

Parameter	Symbol	Va	Unit	
raiametei		Hyper Red	Green	Onit
Power Dissipation	P_{D}	75	102.5	mW
Reverse Voltage	V _R	5	5	V
Junction Temperature	TJ	115	115	°C
Operating Temperature	T _{op}	-40 T	°C	
Storage Temperature	T_{stg}	-40 To +85		°C
DC Forward Current	I _F	30	25	mA
Peak Forward Current	I _{FM} ^[1]	185	150	mA
Electrostatic Discharge Threshold (HBM)	-	3000	450	V

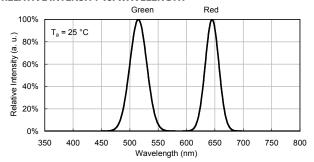
Notes:
1. 1/10 Duty Cycle, 0.1ms Pulse Width.
2. Relative humidity levels maintained between 40% and 60% in production area are recommended to avoid the build-up of static electricity – Ref JEDEC/JESD625-A and JEDEC/J-STD-033.



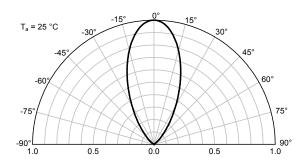


TECHNICAL DATA

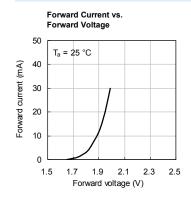
RELATIVE INTENSITY vs. WAVELENGTH

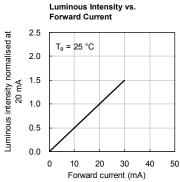


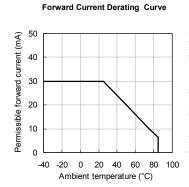
SPATIAL DISTRIBUTION

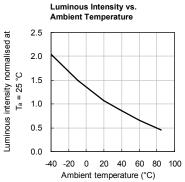


HYPER RED

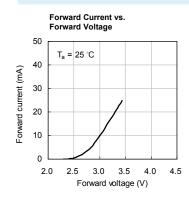


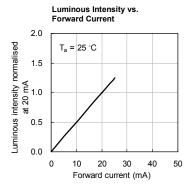


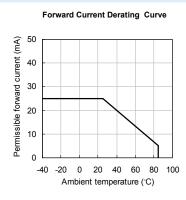


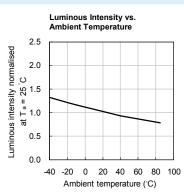


GREEN









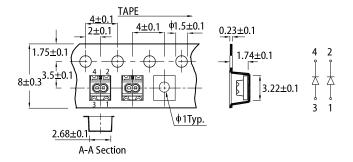


REFLOW SOLDERING PROFILE for LEAD-FREE SMD PROCESS

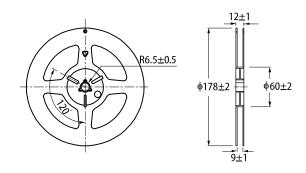
300 above 255°C (°C) 260°C max. 30s max. 10s max. 250 3°C/s max. 6°C/s max. 200 150 Temperature pre-heating 100 above 217°C 150~200°C 60~120s 60~150s 50 50 100 150 200 250 Time -

- 1. Don't cause stress to the LEDs while it is exposed to high temperature.
 2. The maximum number of reflow soldering passes is 2 times.
 3. Reflow soldering is recommended. Other soldering methods are not recommended as they might cause damage to the product

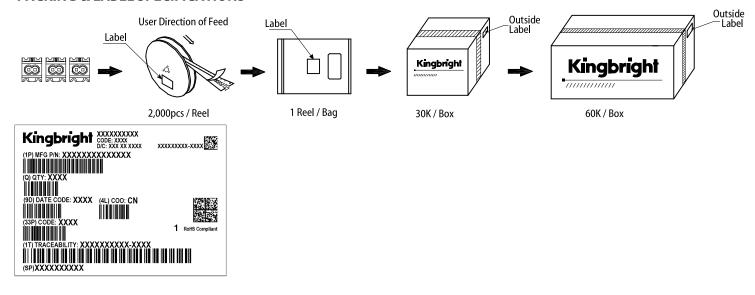
TAPE SPECIFICATIONS (units: mm)



REEL DIMENSION (units: mm)



PACKING & LABEL SPECIFICATIONS



PRECAUTIONARY NOTES

- The information included in this document reflects representative usage scenarios and is intended for technical reference only.
- The part number, type, and specifications mentioned in this document are subject to future change and improvement without notice. Before production usage customer should refer to
- the latest datasheet for the updated specifications.

 When using the products referenced in this document, please make sure the product is being operated within the environmental and electrical limits specified in the datasheet. If customer usage exceeds the specified limits, Kingbright will not be responsible for any subsequent issues.
- The information in this document applies to typical usage in consumer electronics applications. If customer's application has special reliability requirements or have life-threatening liabilities, such as automotive or medical usage, please consult with Kingbright representative for further assistance.
- The contents and information of this document may not be reproduced or re-transmitted without permission by Kingbright.
- All design applications should refer to Kingbright application notes available at https://www.Kingl



Mouser Electronics

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

Kingbright:

APBL3025SURKZGKC